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IN THE SPECIFICATION:

Please amend the indicated paragraphs of the specification in accordance with the amendments indicated below.

Please delete the Title of the Invention and replace it with the following title:

COAGUANT, PROCESS FOR PRODUCING SAME, AND METHOD OF
COAGULATION WITH THE COAGULANT FLOCCULANT.

MANUFACTURING METHOD THEREFOR, AND FLOCCULATION
METHOD USING THE FLOCCULANT

Please delete the paragraph at page 2, line 1 and replace it with the following paragraph:

(Patent Literature 1) Unexamined Patent Application Number 20003-38908 (Japan).

Please delete the paragraph at page 2 line 2 and replace it with the following paragraph:

(Patent Literature 2) Patent Number 2759853 (Japan).

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Please delete the paragraph at page 2 line 3 and replace it with the following paragraph:

(Patent Literature 3) Patent Number 2732067 (Japan).

Please delete the paragraph at page 2, line 4 and replace it with the following paragraph:

(Patent Literature 4) Published Examined Patent Application H4-75796 (Japan).

At page 7, please delete the paragraph beginning at line 1 and replace it with the following paragraph:

The acid solvent favorably contains one, two or more gelation suppressants selected from acetic acid (C₂H₄O₂), ammonium acetate (CH₃COONH₄), and ammonium chloride [[(AlCl₃)]] NH₄Cl₃. Using acetic acid as a gelation suppressant adjusts the quantity of liquid acetic acid added by drops due to the pH buffer action of the acetic acid and the astringency of the solution and colloid, allowing gelation of the silicon colloidal solution to be suppressed. Adding ammonium acetate or ammonium chloride to the diluted hydrochloric

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acid for a mixed acid also suppresses gelation of the silicon colloidal solution, similar to the acetic acid.

Please delete the paragraph beginning on page 8 at line 18 and replace it
with the following paragraph:

In this example of embodiment, Inbu white clay, a natural substance with a high silicon dioxide (SIO₂) and aluminum oxide (Al₂O₃) content was used as the silicon-containing substance, and calcium carbonate [[(CaCO₂)]] (CaCO₃) was used as the alkaline substance.